

PROGRAM

April 25, Wednesday

17.30-19.30	Registration at Telecom Future Centre
19.45-21.00	Welcome Cocktail at Hotel Bonvecchiati

April 26, Thursday

11.45-12.00

12.00-12.15

12.15-12.30 12.30-12.45

8.00-9.00	Registration at Telecom Future Centre
9.00-9.15	Opening Ceremony Paolo Dario, General Chair Mario Zen, General Co-Chair
9.15-10.45	Session 1 Country and Region Review
9.15-9.30 9.30-9.45 9.45-10.00 10.00-10.15 10.15-10.30 10.30-10.45	Australia: Jason Chaffey Benelux: Albert Van Den Berg Canada: Daniel Gale China: Zhaoying Zhou European Commission: Augusto De Albuquerque France: Chantal Khan-Malek
10.45-11.15	Coffee Break
11.15-11.30 11.30-11.45	Germany: Roland Zengerle India: Shiban K Koul

Japan: Isao Shimoyama

Mediterranean: Paolo Dario

Korea: Young Ho-Cho

Nordic: Per Ohlkers

12.45-13.00	Singapore: Albert Lu
13.00-14.00	Lunch
14.00-14.15 14.15-14.30 14.30-14.45 14.45-15.00	Switzerland: Nico De Rooij Taiwan: Pei-Zheng Chang United Kingdom: Geoffrey Beardmore USA: Michael Gaitan
15.00-17.45	Session 2 Tools for Growth: Strategies, Cooperation, Infrastructures and Education
15.00-15.15	Andreas Lymberis, European Commission: Micro-nano systems: opportunities under EU framework program 7 for R&D
15.15-15.30	Sean Neylon, European Commission: MicroBioNano Research activities within the EU: vision from Nexus and outlook to the FP7
15.30-15.45	Gaetan Menozzi, MEMSCAP, Crolles, France: EURIPIDES: the EUREKA initiative for Smart Systems Integration
15.45-16.00	Carles Cané, Centre Nacional de Microelectrònica, Barcelona, Spain: European Technological Platforms: Example of how they are addressed at Spanish level
16.00-16.15 16.15-16.45	Summit picture Coffee Break
	Coffee Break H.W.M. Salemink, Delft University of Technology, Delft, The Netherlands:
16.15-16.45	H.W.M. Salemink, Delft University of Technology, Delft, The Netherlands: NanoNed, the Dutch Nanotechnology Program Veli-Matti Airaksinen, Helsinki University of Technology, Finland: MICRONOVA: the Centre for Micro and
16.15-16.45 16.45-17.00	H.W.M. Salemink, Delft University of Technology, Delft, The Netherlands: NanoNed, the Dutch Nanotechnology Program Veli-Matti Airaksinen, Helsinki University of Technology, Finland: MICRONOVA: the Centre for Micro and Nanotechnologies Dan Dascalu, IMT, Bucharest, Romania: NanoScale and NanoBio Labs developed by national
16.15-16.45 16.45-17.00 17.00-17.15	H.W.M. Salemink, Delft University of Technology, Delft, The Netherlands: NanoNed, the Dutch Nanotechnology Program Veli-Matti Airaksinen, Helsinki University of Technology, Finland: MICRONOVA: the Centre for Micro and Nanotechnologies Dan Dascalu, IMT, Bucharest, Romania: NanoScale and NanoBio Labs developed by national networks: to be used at a regional scale Karan Kaler, University of Calgary, Canada: MEMS, Microfluidics and Microsystems Initiatives
16.15-16.45 16.45-17.00 17.00-17.15	H.W.M. Salemink, Delft University of Technology, Delft, The Netherlands: NanoNed, the Dutch Nanotechnology Program Veli-Matti Airaksinen, Helsinki University of Technology, Finland: MICRONOVA: the Centre for Micro and Nanotechnologies Dan Dascalu, IMT, Bucharest, Romania: NanoScale and NanoBio Labs developed by national networks: to be used at a regional scale Karan Kaler, University of Calgary, Canada:

April 27, Friday

8.30-12.45	Session 3 From Research to Commercialization: Market, Industrialization and Standardization
8.30-8.45	Keiichi Aoyagi, Micromachine Center, Japan: MEMS Industry Forum: Market, Standardization and Industry Development
8.45-9.00	Koichi Karaki, Olympus, Tokyo, Japan: Recent Progress of MEMS and Nano Techonology at Olympus
9.00-9.15	Ian Bates, RMIT University, Melbourne, Australia: Commercialising Microtechnologies: A Funding Perspective
9.15-9.30	Stefan Finkbeiner, Bosh, Germany: MEMS at Robert Bosch - From Automotive to Consumer
9.30-9.45	Norbert Fabricius, Karlsruhe Institute of Technology, Germany: ISO and IEC Standardization Activities in the Field of
9.45-10.00	Nanotechnology Christine Neuy, IVAM Microtechnology Network, Dortmund, Germany: The Special Needs of Small and Medium Enterprises in MEMS
10.00-10.15	Ron Lawes, Imperial College, London, UK: Are High Aspect Ratio Techniques too Expensive for Cost Competitive Foundry Manufacture?
10.15-10.30	Yeau-Ren Jeng, National Chung Cheng University, Taiwan: : Nanotechnology National Program and Its Impacts on Nano-enabled Industries
10.30-11.00	Coffee Break
11.00-11.15	Star Ruey-Shing Huang, National Tsing Hua University, Hsinchu, Taiwan: First Decade Taiwan MEMS: From Academic to Industry Development
11.15-11.30	Gaetan Menozzi, MEMSCAP, Crolles, France: MEMSCAP: set for growth
11.30-11.45	Henning Wicht, WTC, Germany: MEMS industry analysis 2007 - 2010: Changes in the Supply Chain
11.45-12.00	Pascal Ancey, ST Microelectronics, Crolles, France: RF-MEMS & Micro-Nano integrated platforms: development within European projects

12.00-12.15	Roberto De Nuccio, ST Microelectronics, Milan, Italy: MEMS for consumer market
12.15-12.30	Bruce Alton, Micralyne Inc, Alberta, Canada: The Global MEMS Supply Chain: A Foundry's Perspective
12.30-12.45	Androula Nassiopoulou, IMEL/NCSR Demokritos, Greece: Micro&Nano: The Greek micro-nano technology and MEMs Network
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12.45-14.00	Lunch and Meeting of Chief Delegates
14.00-18.45	Session 4 New Concepts and Technologies
14.00-14.15	John Moreland, NIST, USA: Chip Scale Atomic Clocks
14.15-14.30	Wengang Wu, Beijing University, China: Three dimensional nano-assembly by focused ion-beam-stress-introducing technique
14.30-14.45	Jiao Jiwei, Chinese Academy of Science, Shangai, China: Fabrication and Characterization of Nano
14.45-15.00	ElectroMechanical Structures at SIMIT Reiner Wechsung, MicroParts GmbH, Dortmund, Germany: Potentials of Micro-Nano-technologies for Biomedical
15.00-15.15	Applications Thomas Gessner, FhG-IZM, Berlin, Germany: Smart Systems Integration - Introduction of new activities of the Fraunhofer Alliance Microelectronics
15.15-15.30	Vincent Lin, Touch Micro-system Technology, Taiwan: The Evolution of Miniature Opto-mechanics Device
15.30-16.00	Coffee Break
16.00-16.15	Ki-Hun Jeong, KAIST, Seoul, Korea: 3D Polymer Micromachining for Omni-directional Sensor
16.15-16.30	Arrays Marco Lazzarino, CNR-INFM, Trieste, Italy: The twin cantilever approach to the single molecule detection

16.30-16.45	Hyung Dong Kang, Samsung Electro-Mechanics, Korea: Direction of the Development of Next Electronic Components
16.45-17.00	Masao Arakawa, Matsushita Electric Works, Japan: Wafer Level Packaging Technology at Matsushita Electric Works
17.00-17.15	Koichi Imanaka, OMRON Corporation, Japan: Recent Activity on Micro/Nano Technology at OMRON Corporation
17.15-17.30	Ilkka Tittonen, TKK, Finland: Rapid Prototyping Process for SOI Based MEMS Devices
17.30-17.45	Markku Tilli, Research Okmetic Oyj, Finland: MEMS Optimized Silicon Material
17.45-18.00	Terry Lee, SST Wireless Inc., Delta, Canada: Integrated Wireless Smart Sensors& Micro-nano Generators
18.00-18.15	Bingchu Cai, Shangai Jiao Tong University, China: Some CNT-related fundamental technologies and its application- breath sensors-
18.15-18.30	Chenyang Xue, North University of China, China: The application of MEMS Devices in dangerous chemical transportation
18.30-18.45	Conclusions and presentation of MMS '08
18.45-20.00	Farewell Party at Telecom Future Centre

April 28, Saturday

Technical Tours

9.30-12.30	NanoFab, Marghera

8.30-18.00 ITC, Trento